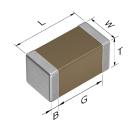
积层贴片陶瓷片式电容器

C1608X5R0J156M080AC

RoHS Reach Halogen Free Pb Free

交货型号	C1608X5R0J156MT****
用途	一般等级
特点	General 一般(~75V)
系列	C1608 [EIA 0603]
状态	量产体制



)	₹∜
长度(L)	1.60mm ±0.20mm
宽度(W)	0.80mm ±0.20mm
厚度(T)	0.80mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.30mm Min.
推荐焊盘布局(PA)	0.70mm to 1.00mm (Flow Soldering)
1世行。序血·仰·问(tī n)	0.60mm to 0.80mm (Reflow Soldering)
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)
推存序益和/ng (FB)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)
1世代丹血州内はい	0.60mm to 0.80mm(Reflow Soldering)

电气特性		
电容	15 μ F ±20%	
额定电压	6. 3VDC	
温度特性	$X5R(\pm 15\%)$	
耗散因数(Max.)	10%	
绝缘电阻 (Min.)	6ΜΩ	

	其他	
	流体	
焊接方法	回流	
AEC-Q200	NO NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

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[!] All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

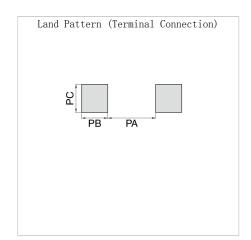
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Associated Images



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